





OPTION

-WT

= Weld Tabs

(Standard on

optional on -01

card thickness)

-K

02 card thickness

(1,27 mm) .050" **MECF SERIES**

MICRO EDGE CARD SOCKET

(67,61) 2.662 (65,79) 2.590 (71,68) 2.822 (69,60) 2.740

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?MECF-DV

Insulator Material: -01=Black Liquid Crystal Polymer -02=Natural Liquid Crystal Polymer Contact Material:

BeCu Plating: Sn or Au over 50µ" (1,27 µm) Ni Operating Temp Range: -55°C to +125°C Current Rating: 2.54 per contact

2.5A per contact @ 95°C ambient Voltage Rating: 280 VAC **RoHS Compliant:**

Processing:

Lead-Free Solderable: SMT Lead Coplanarity: (0,10 mm) .004" max (05-30) (0,15 mm) .006" max (40-50)

APPLICATION SPECIFIC

Non-polarized Call Samtec.

POSITIONS

PER ROW

-05

-08

-20

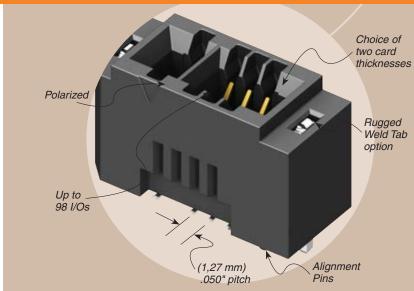
-30

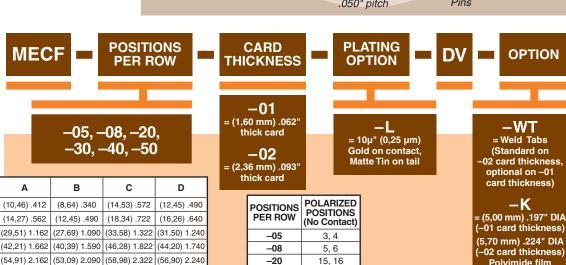
-40

-50

Mates with:

(1,60 mm) .062" card, (2,36 mm) .093" card

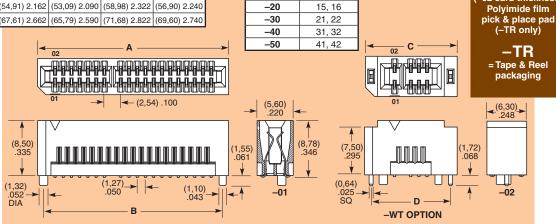




Note: While optimized for 50Ω applications, this connector with alternative signal/ground patterns may also perform well in certain 75Ω applications. Contact Samtec for further information.

Note: Other Gold plating options available. Contact Samtec.

Note: Some sizes, styles and options are non-standard, non-returnable



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Due to technical progress, all designs, specifications and components are subject to change without notice.

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